

**Joint Steering Committee (JSTC)
Of the World Semiconductor Council (WSC)
February 18, 2005**

JSTC Statement on the Green House Gas Legislation

The semiconductor industry has long recognized the importance of protecting the global environment. In view of the significance of preventing global climate change, the World Semiconductor Council (WSC)¹ proactively agreed in 1999 to reduce the aggregate absolute emissions of PFC's from the semiconductor fabrication facilities by at least 10% by the year 2010.² This commitment to reduce emissions was made despite the very rapid growth in manufacturing output in the semiconductor industry.

This agreement, which has been undertaken in a strictly voluntary manner, has led to significant progress being made. That progress is verified through the WSC. Each year, the WSC member associations collect emission data of gases including PFC that have impact on climate change, and provide that information to WSC to confirm progress made toward achieving the goal.

The WSC is in the process of finalizing plans to make this data available to stakeholders in an easily understandable and appropriate way.

The Governments/Authorities of the five members associations of the WSC have expressed their support for these voluntary activities. In fact, in 1998, the United States Environmental Protection Agency (EPA) presented the WSC with its prestigious Global Climate Protection Award.

The WSC agreement provides a means through which companies from all the WSC regions can work together to pursue environmentally sound policies in a manner that does not lead to the disclosure of confidential or proprietary information in a competitive marketplace – and that is part of the reason for the tremendous success of the program. Any policy proposal or legislation that risks the exposure of company specific confidential business information would not have the support of the industry..

¹ The WSC is comprised of the semiconductor industry associations representing companies in the European Union, Japan, Korea, Taiwan and the United States.

² In 1999, the associations representing the EU, Japan, Korea and the United States reached agreement; the association representing Taiwan signed on in 2000. The baseline year for EECA, EIAJ, and SIA is 1995, and that for KSIA is 1997, and the baseline year for Taiwan is 1998* (average of 1997 and 1999).

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